



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Application of:

Kevin P. O'Brien, *et al.*

Application No.: 10/814,592

Filed: March 31, 2004

Assignee: Intel Corporation

Confirmation No.: 5877

For: CAPPING OF COPPER
STRUCTURES IN
HYDROPHOBIC ILD USING
AQUEOUS ELECTRO-LESS
BATH

Examiner: Berry, Renee R.

Group Art Unit: 2891

CERTIFICATE OF TRANSMISSION/MAILING

I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313-1450 on this date: 4/20/05

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Signature: Yvette L. Chriscaden Date: 4/20/05

Mail Stop Amendment
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE TO OFFICE ACTION

To The Commissioner for Patents:

INTRODUCTORY COMMENTS

This paper is in response to the Office Action dated March 23, 2005. The shortened period for response extends to June 23, 2005. Claims 1-9 have been rejected by the Examiner. Reconsideration of the above-captioned application is respectfully requested in view of the amendments as follows.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Amendments to the Drawings begin on page 15 of this paper and include attached replacement sheets.

Remarks/Arguments begin on page 16 of this paper.